



Cyber Partnerships for Sustainability



**Implementation
Matters**

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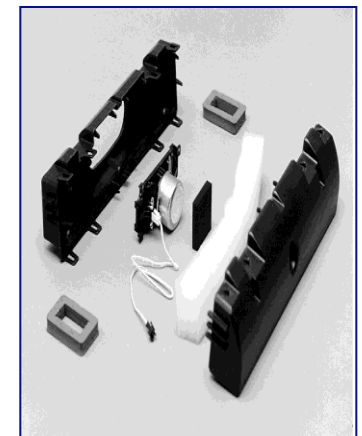
Contents

- First Steps towards Sustainability
- New information relationships
- Connectivity needs
 - Industry level
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- Discussion



First Steps

- New Product Designs
 - Lead free,
 - Recyclable materials
 - Modular component blocks for re-use
 - Design for fast disassembly
- New Production techniques
 - Towards zero emission
 - waste elimination
 - Use of smart and/or recycled materials





New Information Relationships

- Employees
 - Well-being, Assurance, Ethics, Morale
 - Health & Safety
 - Training, Workplace Codes, First Aid Information Support



New Information Relationships

Consumer & Retailer

- Product data
 - Recyclability, Substances, Warranties
- New product - consumer relationships
 - Lease, share
 - Product Exchange Service
- Corporate Policy and Activity
 - Green Management Plan and Targets





New Information Relationships

- Recyclers
 - Location of valuable components materials
 - Optimal disassembly techniques
 - Component lifetime diagnosis
 - Residual component, material values
- Authorities
 - Recycling Targets
 - Certification of recycling, take-back service



Connectivity Needs

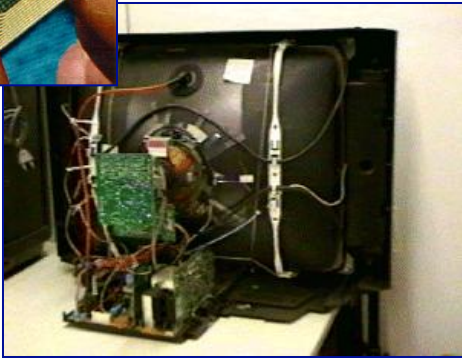
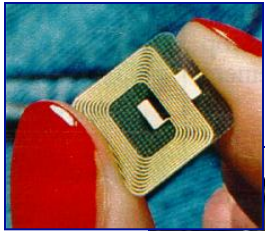
- European Scale Examples from the Strategic CARE Project
 - Identification Unit
 - Smart Materials
 - Biodegradable Printed Wiring Boards
 - European Governments



Connectivity Needs - Industry level

ID Unit Project

Data Chip In Waste TV



Product data



Retailer

Municipality

Haulage Co's

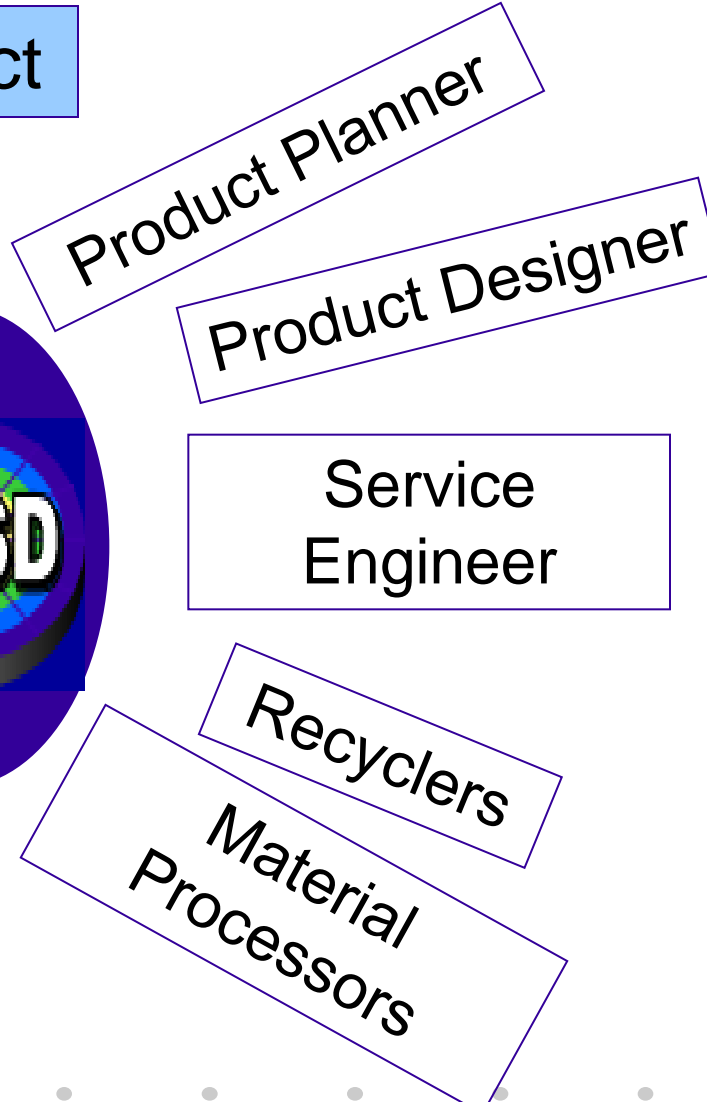
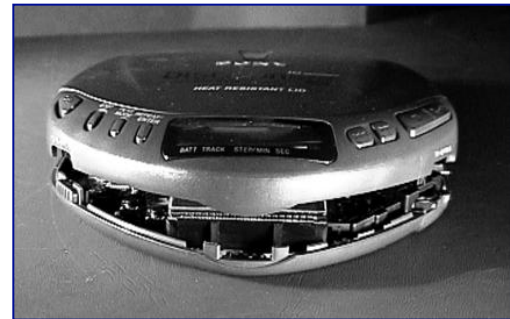
Recyclers

Material Processors

Connectivity needs - Corporate level

Smart Materials Project

Self Disassembly
Low End Products





Connectivity needs - Project level

Bio degradable PWB's

Plant Extensin
Material



Universities

Manufacturers

Institutes

Recyclers

Material
Processors



Annex - Break





Annex - Industry Partners - SCARE

- Philips
- Siemens, DE
- ICL, BE
- Motorola, DE, IE, PL
- Bosch, DE
- SONY, DE
- Indumetal Recycling, ES
- ALCATEL ICT, FR
- Rumpold, AT
- ERA Technology, UK
- STENA Technoworld, SE



- TESLA-ECIMEX, CZ
- ECOBILAN, FR
- GAIA, ES
- Miljo- og Innovationscenter Egen Mark, DK
- PI Management, NL
- Ploos van Amstel, NL
- Rendan, DK





Annex - Political Network

- European
 - Head Commissioner for Industry, Research & Information Society
 - DG Research C1 head of IPPO Key Action
 - DG Research C1 head of industrial and material technologies unit
 - DG Research AP2 Official Commission contact for Eureka
 - DG Research E Head of unit for Industrial and Emerging countries

